

MSL-824SG

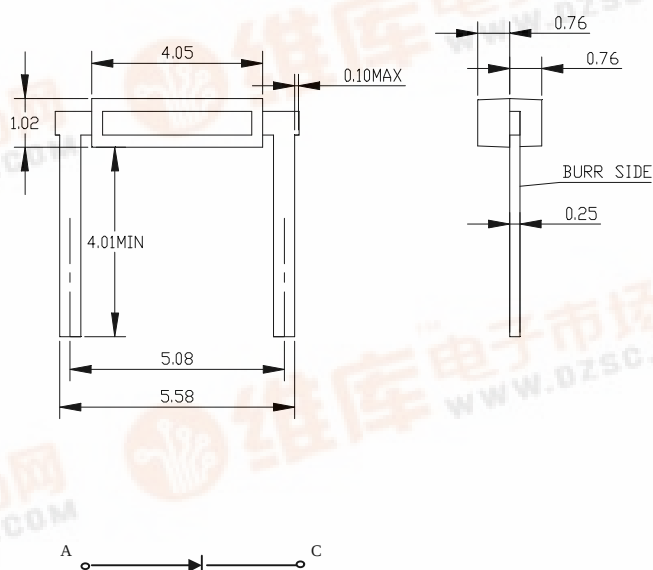
Package Dimensions

The package is water clear epoxy within white plastic.

Units : mm

- LCD backlighting
- Symbol backlighting
- Front panel indicator

- High performance
- Excellent chip to chip consistency
- High reliability



Notes :

- Notes :
1. All dimensions are in millimeters.
 2. Tolerance is ± 0.1 mm unless otherwise noted.

Absolute Maximum Ratings

@ $T_A = 25^\circ\text{C}$

Parameter	Symbol	Maximum Rating	Unit
Power Dissipation	P _{ad}	100	mW
Continuous Forward Current	I _{af}	25	mA
Reverse Current(V _R =5V)	I _R	10	μA
Operating Temperature Range	T _{opr}	-40°C to +85°C	
Storage Temperature Range	T _{stg}	-40°C to +85°C	
Lead Soldering Temperature 260°C for 5 second (2.0mm From Body)			

Optical-Electrical Characteristics

'@ $T_A=25^{\circ}\text{C}$

PART NO	Color		Peak Wave Length $\lambda_D(\text{nm})$	Spectral Halfwidth $\Delta\lambda(\text{nm})$	Forward Voltage @ $I_F=20\text{mA}$ (V)		Luminous Intensity @ $I_F=20\text{mA}$ (mcd)		Viewing Angle $2\theta_{1/2}$ (deg)
	Emitted	Lens			TYP	MAX	MIN	TYP	
MSL-824SG	Signal Green	Water Clear	505	30	3.5	4.0	175	260	110

Typical Optical-Electrical Characteristic Curves

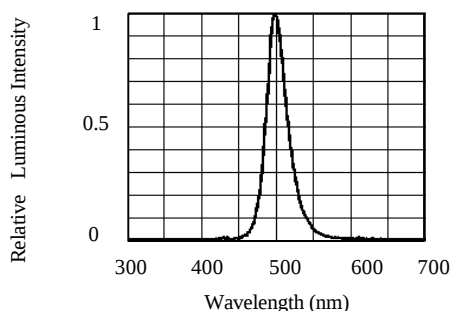


FIG.1 RELATIVE LUMINOUS INTENSITY VS. WAVELENGTH

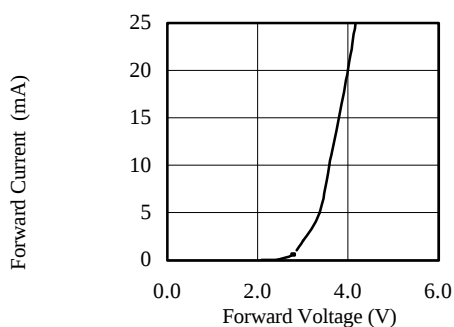


FIG.2 FORWARD CURRENT VS. FORWARD VOLTAGE

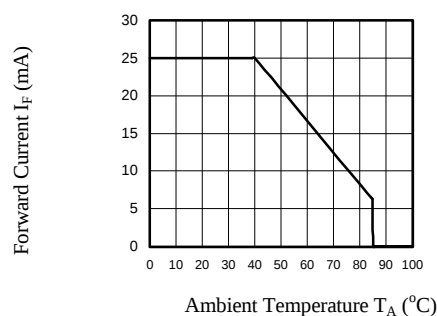


FIG.3 FORWARD CURRENT VS. AMBIENT TEMPERATURE

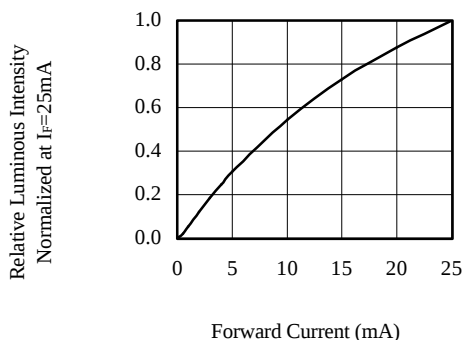


FIG.4 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

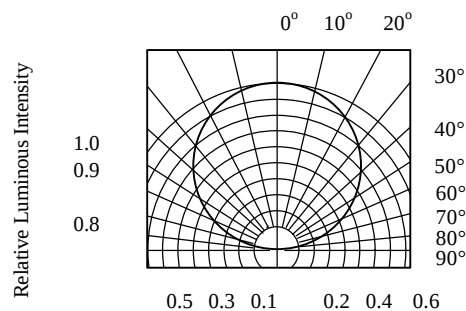


FIG.5 RADIATION PATTERN DIAGRAM